

GLASS PASSIVATED SUPER FAST RECOVERY BRIDGE RECTIFIERS

Voltage Range - 200 to 600 Volts Current - 0.8/1.0 Ampere

Features

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High temperature soldering guaranteed: 260°C/10 second at 5 lbs., (2.3kg) tension
- Small size, simple installation
- Leads solderable per MIL-STD-202, Method 208
- High surge current capability
- Super fast switching for high efficiency
- Glass passivated chip junction
- Glass compound (halogen & Sb₂O₃ free)

Mechanical Data

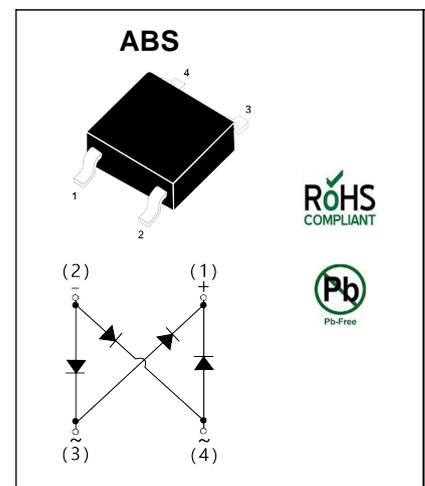
- Case: Molded plastic body
- Terminals: Plated lead solderable per MIL-STD-750, Method 2026
- Polarity: Polarity symbols marked on case
- Mounting Position: Any

Specification

Maximum Rating And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load derate current by 20%.



| | SYMBOLS | EABS2 | EABS4 | EABS6 | EABS8 | UNITS |
|-------------------------------------------------------------------------------------------------------------|--------------------------------------|-------|-------------|-------|-------|----------|
| Maximum repetitive peak reverse voltage | V _{RRM} | 100 | 200 | 400 | 600 | V |
| Maximum RMS voltage | V _{RMS} | 70 | 140 | 280 | 420 | V |
| Maximum DC blocking voltage | V _{DC} | 100 | 200 | 400 | 600 | V |
| Maximum average forward rectified current On glass-epoxy P.C.B.(Note1) On aluminum substrate(Note2) | I _{F(AV)} | | 0.8 1.0 | | | A |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | | 30 | | | A |
| Maximum instantaneous forward voltage drop per leg at 0.4A | V _F | 0.95 | | 1.25 | 1.7 | V |
| Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C | I _R | | 5.0 500 | | | uA uA |
| Typical thermal resistance(NOTE 3) | R _{θJL} R _{θJA} | | 25 75 | | | °C/W |
| Maximum reverse recovery time (NOTE 4) | t _{rr} | | 35 | | | ns |
| Operating temperature range | T _J | | -55 to +150 | | | °C |
| storage temperature range | T _{STG} | | -55 to +150 | | | °C |

NOTES: 1. On glass epoxy P.C.B. mounted on 0.05x0.05"(1.3x1.3mm) pads.
 2. On aluminum substrate P.C.B. with an area of 0.8"x0.8"(20x20mm) mounted on 0.05X0.05"(1.3X1.3mm) solder pad.
 3. Thermal resistance form junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2"(5X5mm) copper pads.
 4. Reverse recovery condition I_F=0.5A, I_R=1.0A, I_{rr}=0.25A.

Ratings and characteristic curves EABS2 thru EABS8

FIG.1 FORWARD DERATING CURVE

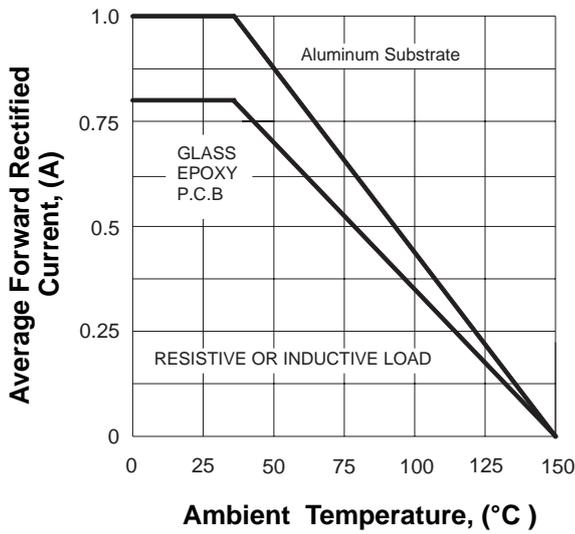


FIG.2 PEAK FORWARD SURGE CURRENT

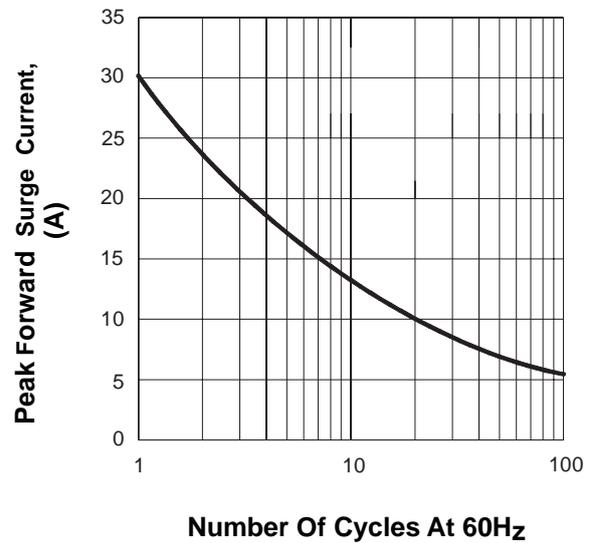


FIG.3 TYPICAL FORWARD CHARACTERISTICS

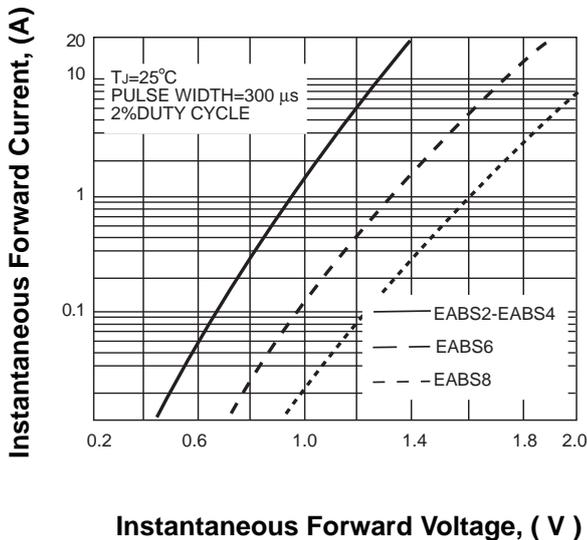
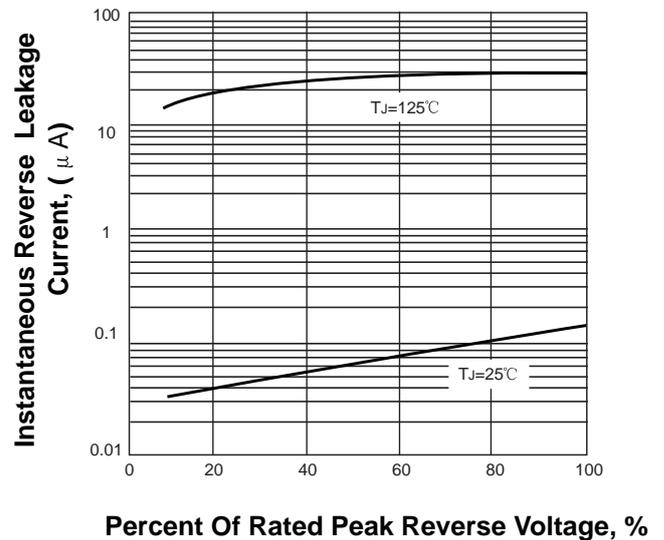
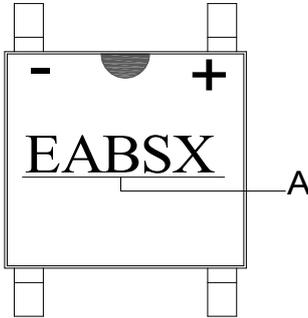


FIG.4 TYPICAL REVERSE CHARACTERISTICS

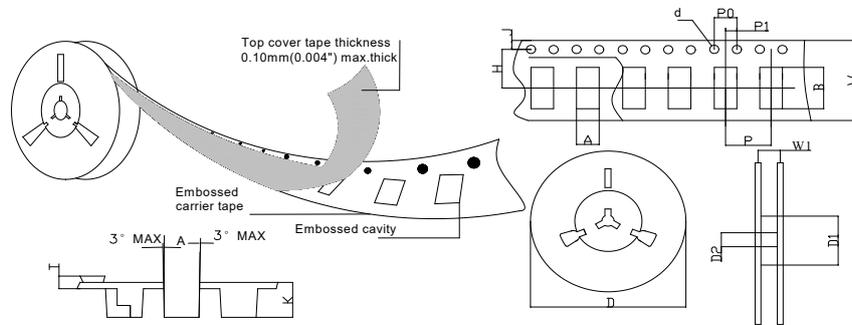


1、Marking



| SYMBOL | Explanation |
|--------|--------------|
| A | Product Name |

2、Packaging



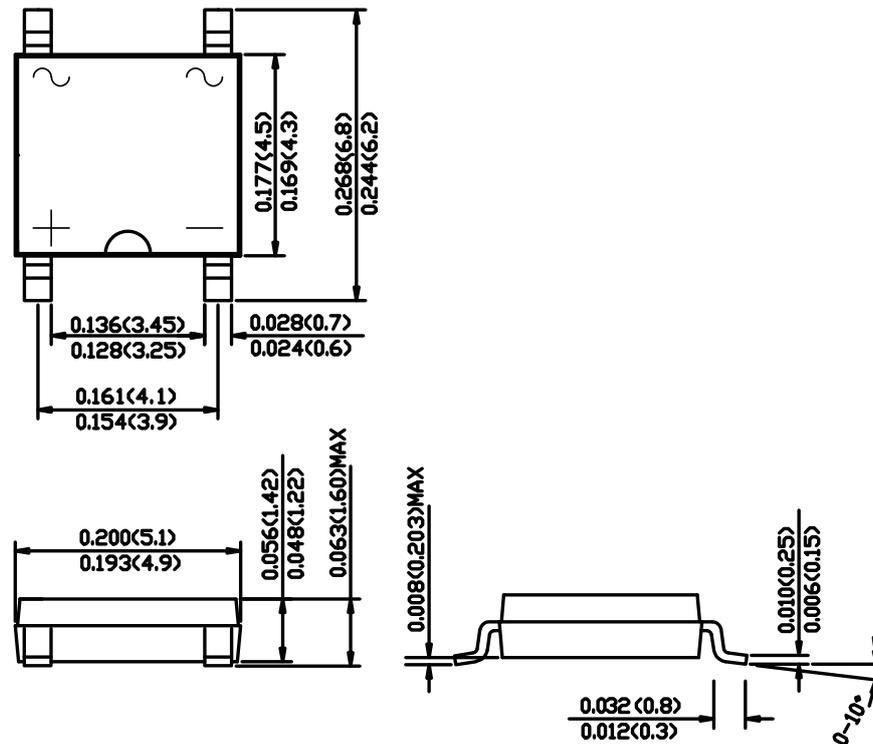
| SPECIFICATIONS mm(inch) | | PACKAGE | SPECIFICATIONS mm(inch) | | PACKAGE |
|----------------------------|------------|-----------------|----------------------------|------------|----------------|
| ITEM | SYM BOL | ABS | ITEM | SYM BOL | ABS |
| Carrier width | A | 5.45(0.215)Max | Carrier depth | K | 1.60(0.063)Typ |
| Carrier length | B | 7.0(0.276)Max | Punch hole pitch | P | 8.00(0.315)Typ |
| Sprocket hole | d | ø1.55(0.061)Typ | Sprocket hole pitch | P0 | 4.00(0.157)Typ |
| Reel outer diameter | D | 330.0(13.0)Typ | Embossment center | P1 | 2.00(0.079)Typ |
| Reel inner diameter | D1 | 50.0(2.913)Min | Overall tape thickness | T | 0.30(0.012)Typ |
| Feed hole diameter | D2 | 13.0(0.512)Typ | Tape width | W | 12.0(0.472)Typ |
| Sprocket hole position | J | 1.75(0.069)Typ | Reel width | W1 | 12.4(0.488)Min |
| Punch hole position | H | 5.50(0.217)Typ | | | |

3、Ordering Information

| Part Number | Compliance | Case | Packaging |
|-------------|------------|------|------------------|
| EABSX | Standard | ABS | 5000/Tape & Reel |

Dimension

ABS



Dimensions in inches and (millimeters)

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